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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	RL78
Core Size	16-Bit
Speed	24MHz
Connectivity	CSI, I <sup>2</sup> C, LINbus, UART/USART
Peripherals	DMA, LCD, LVD, POR, PWM, WDT
Number of I/O	42
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	1.6V ~ 5.5V
Data Converters	A/D 9x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LFQFP (10x10)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f10wlgafb-50">https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f10wlgafb-50</a>

**Absolute Maximum Ratings (2/3)**

Parameter	Symbol	Conditions	Ratings	Unit
LCD voltage	V <sub>L1</sub>	V <sub>L1</sub> voltage <sup>Note 1</sup>	-0.3 to +2.8 and -0.3 to V <sub>L4</sub> +0.3	V
	V <sub>L2</sub>	V <sub>L2</sub> voltage <sup>Note 1</sup>	-0.3 to V <sub>L4</sub> +0.3 <sup>Note 2</sup>	V
	V <sub>L3</sub>	V <sub>L3</sub> voltage <sup>Note 1</sup>	-0.3 to V <sub>L4</sub> +0.3 <sup>Note 2</sup>	V
	V <sub>L4</sub>	V <sub>L4</sub> voltage <sup>Note 1</sup>	-0.3 to +6.5	V
	V <sub>LCAP</sub>	CAPL, CAPH voltage <sup>Note 1</sup>	-0.3 to V <sub>L4</sub> +0.3 <sup>Note 2</sup>	V
	V <sub>OUT</sub>	COM0 to COM7 SEG0 to SEG50 output voltage	External resistance division method	-0.3 to V <sub>DD</sub> +0.3 <sup>Note 2</sup>
			Capacitor split method	-0.3 to V <sub>DD</sub> +0.3 <sup>Note 2</sup>
			Internal voltage boosting method	-0.3 to V <sub>L4</sub> +0.3 <sup>Note 2</sup>

**Notes 1.** This value only indicates the absolute maximum ratings when applying voltage to the V<sub>L1</sub>, V<sub>L2</sub>, V<sub>L3</sub>, and V<sub>L4</sub> pins; it does not mean that applying voltage to these pins is recommended. When using the internal voltage boosting method or capacitance split method, connect these pins to V<sub>SS</sub> via a capacitor (0.47  $\mu$ F  $\pm$  30%) and connect a capacitor (0.47  $\mu$ F  $\pm$  30%) between the CAPL and CAPH pins.

**2.** Must be 6.5 V or lower.

**Caution** Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

**Remark** V<sub>SS</sub>: Reference voltage

## 2.3.2 Supply current characteristics

 $(T_A = -40$  to  $+85^\circ\text{C}$ ,  $1.6\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V})$ 

(1/2)

Parameter	Symbol	Conditions				MIN.	TYP.	MAX.	Unit
Supply current <sup>Note 1</sup>	$I_{DD1}$	Operating mode	HS (high-speed main) mode <sup>Note 5</sup>	$f_{HOCO} = 48\text{ MHz}^{\text{Note 3}}$ , $f_{IH} = 24\text{ MHz}^{\text{Note 3}}$	Basic operation	$V_{DD} = 5.0\text{ V}$	2.0		mA
						$V_{DD} = 3.0\text{ V}$	2.0		mA
					Normal operation	$V_{DD} = 5.0\text{ V}$	3.8	6.5	mA
						$V_{DD} = 3.0\text{ V}$	3.8	6.5	mA
				$f_{HOCO} = 24\text{ MHz}^{\text{Note 3}}$ , $f_{IH} = 24\text{ MHz}^{\text{Note 3}}$	Basic operation	$V_{DD} = 5.0\text{ V}$	1.7		mA
						$V_{DD} = 3.0\text{ V}$	1.7		mA
					Normal operation	$V_{DD} = 5.0\text{ V}$	3.6	6.1	mA
						$V_{DD} = 3.0\text{ V}$	3.6	6.1	mA
				$f_{HOCO} = 16\text{ MHz}^{\text{Note 3}}$ , $f_{IH} = 16\text{ MHz}^{\text{Note 3}}$	Normal operation	$V_{DD} = 5.0\text{ V}$	2.7	4.7	mA
						$V_{DD} = 3.0\text{ V}$	2.7	4.7	mA
			LS (low-speed main) mode <sup>Note 5</sup>	$f_{HOCO} = 8\text{ MHz}^{\text{Note 3}}$ , $f_{IH} = 8\text{ MHz}^{\text{Note 3}}$	Normal operation	$V_{DD} = 3.0\text{ V}$	1.2	2.1	mA
						$V_{DD} = 2.0\text{ V}$	1.2	2.1	mA
			LV (low-voltage main) mode <sup>Note 5</sup>	$f_{HOCO} = 4\text{ MHz}^{\text{Note 3}}$ , $f_{IH} = 4\text{ MHz}^{\text{Note 3}}$	Normal operation	$V_{DD} = 3.0\text{ V}$	1.2	1.8	mA
						$V_{DD} = 2.0\text{ V}$	1.2	1.8	mA
			HS (high-speed main) mode <sup>Note 5</sup>	$f_{MX} = 20\text{ MHz}^{\text{Note 2}}$ , $V_{DD} = 5.0\text{ V}$	Normal operation	Square wave input	3.0	5.1	mA
						Resonator connection	3.2	5.2	mA
				$f_{MX} = 20\text{ MHz}^{\text{Note 2}}$ , $V_{DD} = 3.0\text{ V}$	Normal operation	Square wave input	2.9	5.1	mA
						Resonator connection	3.2	5.2	mA
				$f_{MX} = 16\text{ MHz}^{\text{Note 2}}$ , $V_{DD} = 5.0\text{ V}$	Normal operation	Square wave input	2.5	4.4	mA
						Resonator connection	2.7	4.5	mA
				$f_{MX} = 16\text{ MHz}^{\text{Note 2}}$ , $V_{DD} = 3.0\text{ V}$	Normal operation	Square wave input	2.5	4.4	mA
						Resonator connection	2.7	4.5	mA
				$f_{MX} = 10\text{ MHz}^{\text{Note 2}}$ , $V_{DD} = 5.0\text{ V}$	Normal operation	Square wave input	1.9	3.0	mA
						Resonator connection	1.9	3.0	mA
				$f_{MX} = 10\text{ MHz}^{\text{Note 2}}$ , $V_{DD} = 3.0\text{ V}$	Normal operation	Square wave input	1.9	3.0	mA
						Resonator connection	1.9	3.0	mA
			LS (low-speed main) mode <sup>Note 5</sup>	$f_{MX} = 8\text{ MHz}^{\text{Note 2}}$ , $V_{DD} = 3.0\text{ V}$	Normal operation	Square wave input	1.1	2.0	mA
						Resonator connection	1.1	2.0	mA
				$f_{MX} = 8\text{ MHz}^{\text{Note 2}}$ , $V_{DD} = 2.0\text{ V}$	Normal operation	Square wave input	1.1	2.0	mA
						Resonator connection	1.1	2.0	mA
			Subsystem clock operation	$f_{SUB} = 32.768\text{ kHz}^{\text{Note 4}}$ , $T_A = -40^\circ\text{C}$	Normal operation	Square wave input	4.0	5.4	$\mu\text{A}$
						Resonator connection	4.3	5.4	$\mu\text{A}$
				$f_{SUB} = 32.768\text{ kHz}^{\text{Note 4}}$ , $T_A = +25^\circ\text{C}$	Normal operation	Square wave input	4.0	5.4	$\mu\text{A}$
						Resonator connection	4.3	5.4	$\mu\text{A}$
				$f_{SUB} = 32.768\text{ kHz}^{\text{Note 4}}$ , $T_A = +50^\circ\text{C}$	Normal operation	Square wave input	4.1	7.1	$\mu\text{A}$
						Resonator connection	4.4	7.1	$\mu\text{A}$
				$f_{SUB} = 32.768\text{ kHz}^{\text{Note 4}}$ , $T_A = +70^\circ\text{C}$	Normal operation	Square wave input	4.3	8.7	$\mu\text{A}$
						Resonator connection	4.7	8.7	$\mu\text{A}$
				$f_{SUB} = 32.768\text{ kHz}^{\text{Note 4}}$ , $T_A = +85^\circ\text{C}$	Normal operation	Square wave input	4.7	12.0	$\mu\text{A}$
						Resonator connection	5.2	12.0	$\mu\text{A}$

(Notes and Remarks are listed on the next page.)

- Notes**
1. Total current flowing into  $V_{DD}$ , including the input leakage current flowing when the level of the input pin is fixed to  $V_{DD}$  or  $V_{SS}$ . The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the LCD controller/driver, A/D converter, LVD circuit, comparator, I/O port, on-chip pull-up/pull-down resistors, and the current flowing during data flash rewrite.
  2. When high-speed on-chip oscillator and subsystem clock are stopped.
  3. When high-speed system clock and subsystem clock are stopped.
  4. When high-speed on-chip oscillator and high-speed system clock are stopped. When setting ultra-low power consumption oscillation ( $AMPHS1 = 1$ ). The current flowing into the LCD controller/driver, 16-bit timer KB20, real-time clock 2, 12-bit interval timer, and watchdog timer is not included.
  5. Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.
    - HS (high-speed main) mode:  $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}@1\text{ MHz to }24\text{ MHz}$   
 $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}@1\text{ MHz to }16\text{ MHz}$
    - LS (low-speed main) mode:  $1.8\text{ V} \leq V_{DD} \leq 5.5\text{ V}@1\text{ MHz to }8\text{ MHz}$
    - LV (low-voltage main) mode:  $1.6\text{ V} \leq V_{DD} \leq 5.5\text{ V}@1\text{ MHz to }4\text{ MHz}$

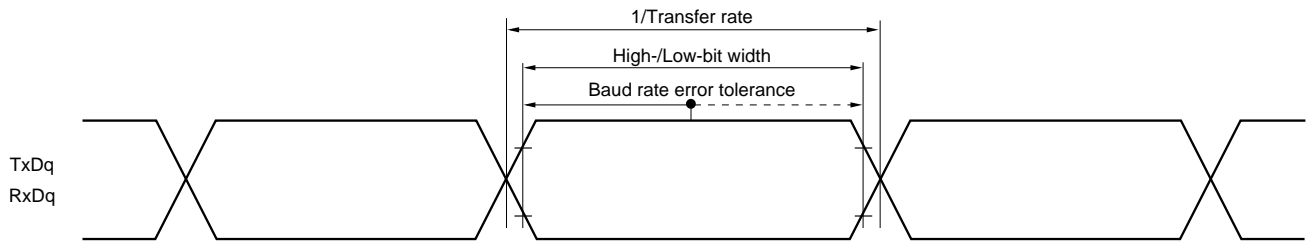
- Remarks**
1.  $f_{MX}$ : High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)
  2.  $f_{HOCO}$ : High-speed on-chip oscillator clock frequency (48 MHz max.)
  3.  $f_{IH}$ : High-speed on-chip oscillator clock frequency (24 MHz max.)
  4.  $f_{SUB}$ : Subsystem clock frequency (XT1 clock oscillation frequency)
  5. Except subsystem clock operation, temperature condition of the TYP. value is  $T_A = 25^\circ\text{C}$

**Notes** 1. Current flowing to  $V_{DD}$ .

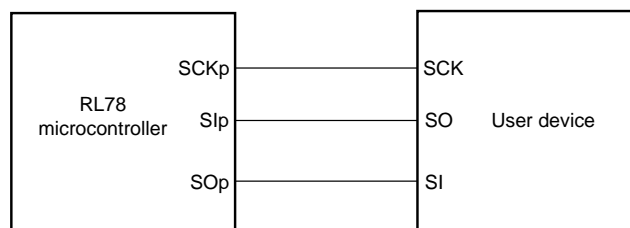
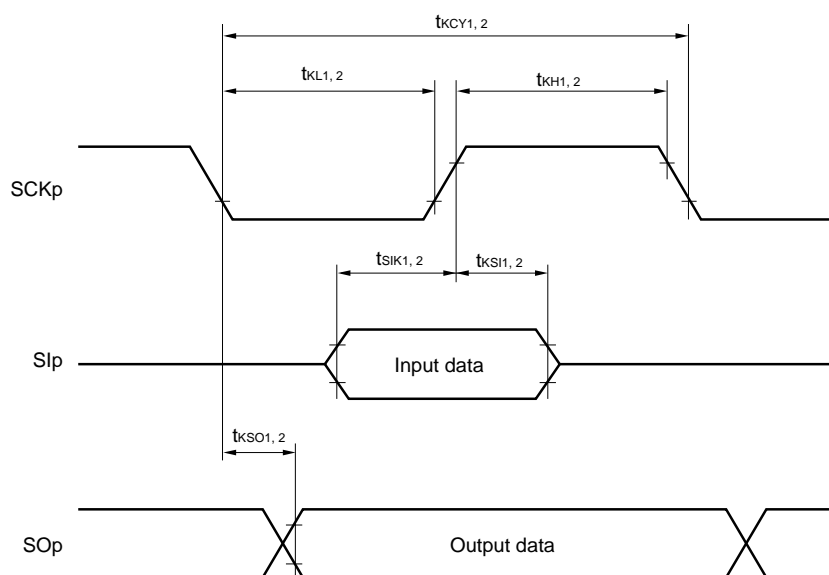
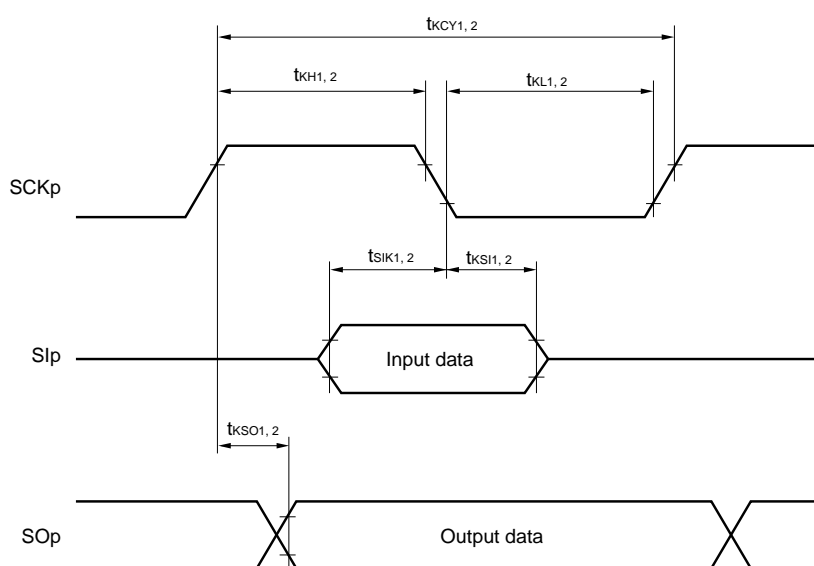
2. When high speed on-chip oscillator and high-speed system clock are stopped.
3. Current flowing only to the real-time clock 2 (excluding the operating current of the low-speed on-chip oscillator and the XT1 oscillator). The value of the current for the RL78 microcontrollers is the sum of the values of either  $I_{DD1}$  or  $I_{DD2}$ , and  $I_{RTC}$ , when the real-time clock 2 operates in operation mode or HALT mode. When the low-speed on-chip oscillator is selected,  $I_{FIL}$  should be added.  $I_{DD2}$  subsystem clock operation includes the operational current of real-time clock 2.
4. Current flowing only to the 12-bit interval timer (excluding the operating current of the low-speed on-chip oscillator and the XT1 oscillator). The value of the current for the RL78 microcontrollers is the sum of the values of either  $I_{DD1}$  or  $I_{DD2}$ , and  $I_{TMKA}$ , when the 12-bit interval timer operates in operation mode or HALT mode. When the low-speed on-chip oscillator is selected,  $I_{FIL}$  should be added.
5. Current flowing only to the watchdog timer (including the operating current of the low-speed on-chip oscillator). The current value of the RL78 microcontrollers is the sum of  $I_{DD1}$ ,  $I_{DD2}$  or  $I_{DD3}$  and  $I_{WDT}$  when the watchdog timer operates.
6. Current flowing only to the A/D converter. The current value of the RL78 microcontrollers is the sum of  $I_{DD1}$  or  $I_{DD2}$  and  $I_{ADC}$  when the A/D converter operates in an operation mode or the HALT mode.
7. Current flowing only to the LVD circuit. The current value of the RL78 microcontrollers is the sum of  $I_{DD1}$ ,  $I_{DD2}$  or  $I_{DD3}$  and  $I_{LVD}$  when the LVD circuit operates.
8. Current flowing only during data flash rewrite.
9. Current flowing only during self programming.
10. **For shift time to the SNOOZE mode, see 21.3.3 SNOOZE mode in the RL78/L13 User's Manual.**
11. Current flowing only to the comparator circuit. The current value of the RL78 microcontrollers is the sum of  $I_{DD1}$ ,  $I_{DD2}$  or  $I_{DD3}$  and  $I_{CMP}$  when the comparator circuit operates.
12. Current flowing only to the LCD controller/driver. The value of the current for the RL78 microcontrollers is the sum of the supply current ( $I_{DD1}$  or  $I_{DD2}$ ) and LCD operating current ( $I_{LCD1}$ ,  $I_{LCD2}$ , or  $I_{LCD3}$ ), when the LCD controller/driver operates in operation mode or HALT mode. However, not including the current flowing into the LCD panel. Conditions of the TYP. value and MAX. value are as follows.
  - Setting 20 pins as the segment function and blinking all
  - Selecting  $f_{SUB}$  for system clock when LCD clock = 128 Hz ( $LCDC0 = 07H$ )
  - Setting four time slices and 1/3 bias
13. Not including the current flowing into the external division resistor when using the external resistance division method.

**Remarks** 1.  $f_{IL}$ : Low-speed on-chip oscillator clock frequency

2.  $f_{SUB}$ : Subsystem clock frequency (XT1 clock oscillation frequency)
3.  $f_{CLK}$ : CPU/peripheral hardware clock frequency
4. The temperature condition for the TYP. value is  $T_A = 25^\circ\text{C}$ .

**UART mode bit width (during communication at same potential) (reference)**

- Remarks**
1. q: UART number (q = 0 to 3), g: PIM and POM number (g = 0, 1, 3)
  2.  $f_{MCK}$ : Serial array unit operation clock frequency  
 (Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13))

**CSI mode connection diagram (during communication at same potential)**
**CSI mode serial transfer timing (during communication at same potential)**  
 (When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1.)

**CSI mode serial transfer timing (during communication at same potential)**  
 (When DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.)


- Remarks**
1. p: CSI number (p = 00, 10)
  2. m: Unit number, n: Channel number (mn = 00, 02)

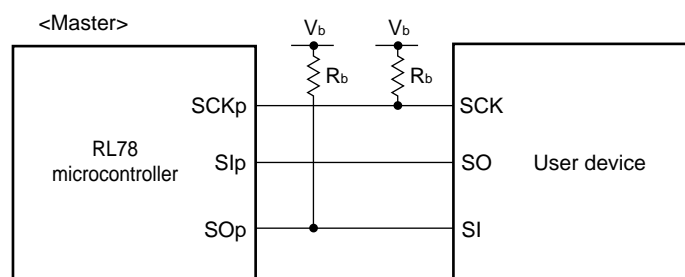
**(7) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (master mode, SCKp... internal clock output) (2/2)**  
**(T<sub>A</sub> = -40 to +85°C, 1.8 V ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = 0 V)**

Parameter	Symbol	Conditions	HS (high-speed main) Mode		LS (low-speed main) Mode		LV (low-voltage main) Mode		Unit
			MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
Slp setup time (to SCKp↓) <sup>Note 4</sup>	t <sub>SIK1</sub>	4.0 V ≤ V <sub>DD</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 1.4 kΩ	44		110		110		ns
		2.7 V ≤ V <sub>DD</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 2.7 kΩ	44		110		110		ns
		1.8 V (2.4 V <sup>Note 1</sup> ) ≤ V <sub>DD</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V <sup>Note 2</sup> , C <sub>b</sub> = 30 pF, R <sub>b</sub> = 5.5 kΩ	110		110		110		ns
Slp hold time (from SCKp↓) <sup>Note 4</sup>	t <sub>KSI1</sub>	4.0 V ≤ V <sub>DD</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 1.4 kΩ	19		19		19		ns
		2.7 V ≤ V <sub>DD</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 2.7 kΩ	19		19		19		ns
		1.8 V (2.4 V <sup>Note 1</sup> ) ≤ V <sub>DD</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V <sup>Note 2</sup> , C <sub>b</sub> = 30 pF, R <sub>b</sub> = 5.5 kΩ	19		19		19		ns
Delay time from SCKp↑ to SOp output <sup>Note 4</sup>	t <sub>KSO1</sub>	4.0 V ≤ V <sub>DD</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 1.4 kΩ		25		25		25	ns
		2.7 V ≤ V <sub>DD</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 2.7 kΩ		25		25		25	ns
		1.8 V (2.4 V <sup>Note 1</sup> ) ≤ V <sub>DD</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V <sup>Note 2</sup> , C <sub>b</sub> = 30 pF, R <sub>b</sub> = 5.5 kΩ		25		25		25	ns

- Notes**
1. Condition in HS (high-speed main) mode
  2. Use it with V<sub>DD</sub> ≥ V<sub>b</sub>.
  3. When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1.
  4. When DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

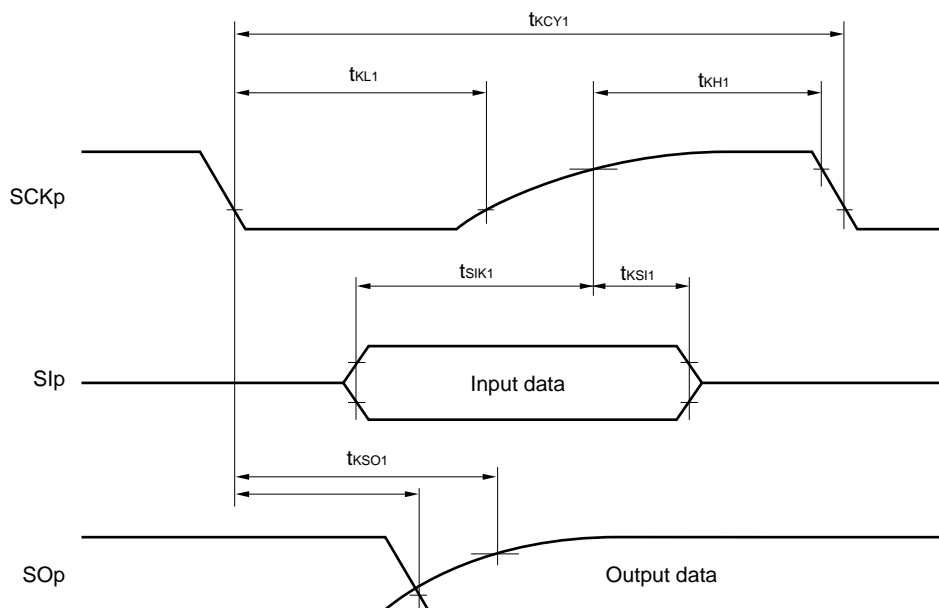
**Caution** Select the TTL input buffer for the Slp pin and the N-ch open drain output (V<sub>DD</sub> tolerance) mode for the SOp pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg). For V<sub>IH</sub> and V<sub>IL</sub>, see the DC characteristics with TTL input buffer selected.

**CSI mode connection diagram (during communication at different potential)**

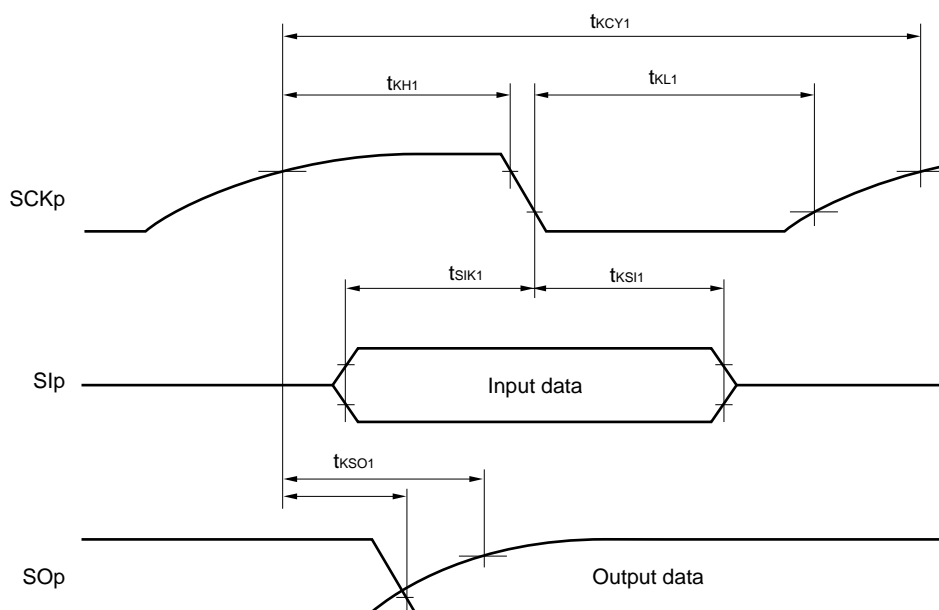




**CSI mode serial transfer timing (master mode) (during communication at different potential)**  
**(When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1.)**



**CSI mode serial transfer timing (master mode) (during communication at different potential)**  
**(When DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.)**



- Remarks 1.**  $R_b[\Omega]$ : Communication line (SCKp, SOp) pull-up resistance,  $C_b[F]$ : Communication line (SCKp, SOp) load capacitance,  $V_b[V]$ : Communication line voltage
- 2.** p: CSI number (p = 00, 10), m: Unit number, n: Channel number (mn = 00, 02), g: PIM and POM number (g = 0, 1)
- 3.**  $f_{MCK}$ : Serial array unit operation clock frequency  
 (Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn).  
 m: Unit number, n: Channel number (mn = 00)

**(8) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (slave mode, SCKp... external clock input)**  
**(T<sub>A</sub> = -40 to +85°C, 1.8 V ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = 0 V)**

Parameter	Symbol	Conditions		HS (high-speed main) Mode		LS (low-speed main) Mode		LV (low-voltage main) Mode		Unit
				MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
SCKp cycle time <sup>Note 1</sup>	t <sub>KCY2</sub>	4.0 V ≤ V <sub>DD</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V	20 MHz < f <sub>MCK</sub>	12/f <sub>MCK</sub>		—		—		ns
			8 MHz < f <sub>MCK</sub> ≤ 20 MHz	10/f <sub>MCK</sub>		—		—		ns
			4 MHz < f <sub>MCK</sub> ≤ 8 MHz	8/f <sub>MCK</sub>		16/f <sub>MCK</sub>		—		ns
			f <sub>MCK</sub> ≤ 4 MHz	6/f <sub>MCK</sub>		10/f <sub>MCK</sub>		10/f <sub>MCK</sub>		ns
		2.7 V ≤ V <sub>DD</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V	20 MHz < f <sub>MCK</sub>	16/f <sub>MCK</sub>		—		—		ns
			16 MHz < f <sub>MCK</sub> ≤ 20 MHz	14/f <sub>MCK</sub>		—		—		ns
			8 MHz < f <sub>MCK</sub> ≤ 16 MHz	12/f <sub>MCK</sub>		—		—		ns
			4 MHz < f <sub>MCK</sub> ≤ 8 MHz	8/f <sub>MCK</sub>		16/f <sub>MCK</sub>		—		ns
			f <sub>MCK</sub> ≤ 4 MHz	6/f <sub>MCK</sub>		10/f <sub>MCK</sub>		10/f <sub>MCK</sub>		ns
		1.8 V (2.4 V <sup>Note 2</sup> ) ≤ V <sub>DD</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V <sup>Note 3</sup>	20 MHz < f <sub>MCK</sub>	36/f <sub>MCK</sub>		—		—		ns
			16 MHz < f <sub>MCK</sub> ≤ 20 MHz	32/f <sub>MCK</sub>		—		—		ns
			8 MHz < f <sub>MCK</sub> ≤ 16 MHz	26/f <sub>MCK</sub>		—		—		ns
			4 MHz < f <sub>MCK</sub> ≤ 8 MHz	16/f <sub>MCK</sub>		16/f <sub>MCK</sub>		—		ns
			f <sub>MCK</sub> ≤ 4 MHz	10/f <sub>MCK</sub>		10/f <sub>MCK</sub>		10/f <sub>MCK</sub>		ns
SCKp high-/low-level width	t <sub>KH2</sub> , t <sub>KL2</sub>	4.0 V ≤ V <sub>DD</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V		t <sub>KCY2</sub> /2 - 12		t <sub>KCY2</sub> /2 - 50		t <sub>KCY2</sub> /2 - 50		ns
		2.7 V ≤ V <sub>DD</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V		t <sub>KCY2</sub> /2 - 18		t <sub>KCY2</sub> /2 - 50		t <sub>KCY2</sub> /2 - 50		ns
		1.8 V (2.4 V <sup>Note 2</sup> ) ≤ V <sub>DD</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V <sup>Note 3</sup>		t <sub>KCY2</sub> /2 - 50		t <sub>KCY2</sub> /2 - 50		t <sub>KCY2</sub> /2 - 50		ns
Slp setup time (to SCKp↑) <sup>Note 4</sup>	t <sub>SIK2</sub>	4.0 V ≤ V <sub>DD</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V		1/f <sub>MCK</sub> + 20		1/f <sub>MCK</sub> + 30		1/f <sub>MCK</sub> + 30		ns
		2.7 V ≤ V <sub>DD</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V		1/f <sub>MCK</sub> + 20		1/f <sub>MCK</sub> + 30		1/f <sub>MCK</sub> + 30		ns
		1.8 V (2.4 V <sup>Note 2</sup> ) ≤ V <sub>DD</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V <sup>Note 3</sup>		1/f <sub>MCK</sub> + 30		1/f <sub>MCK</sub> + 30		1/f <sub>MCK</sub> + 30		ns
Slp hold time (from SCKp↑) <sup>Note 5</sup>	t <sub>SI2</sub>	4.0 V ≤ V <sub>DD</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V		1/f <sub>MCK</sub> + 31		1/f <sub>MCK</sub> + 31		1/f <sub>MCK</sub> + 31		ns
		2.7 V ≤ V <sub>DD</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V		1/f <sub>MCK</sub> + 31		1/f <sub>MCK</sub> + 31		1/f <sub>MCK</sub> + 31		ns
		1.8 V (2.4 V <sup>Note 2</sup> ) ≤ V <sub>DD</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V <sup>Note 3</sup>		1/f <sub>MCK</sub> + 31		1/f <sub>MCK</sub> + 31		1/f <sub>MCK</sub> + 31		ns
Delay time from SCKp↓ to SOp output <sup>Note 6</sup>	t <sub>KSO2</sub>	4.0 V ≤ V <sub>DD</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 1.4 kΩ			2/f <sub>MCK</sub> + 120		2/f <sub>MCK</sub> + 573		2/f <sub>MCK</sub> + 573	ns
		2.7 V ≤ V <sub>DD</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 2.7 kΩ			2/f <sub>MCK</sub> + 214		2/f <sub>MCK</sub> + 573		2/f <sub>MCK</sub> + 573	ns
		1.8 V (2.4 V <sup>Note 2</sup> ) ≤ V <sub>DD</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V <sup>Note 3</sup> , C <sub>b</sub> = 30 pF, R <sub>b</sub> = 5.5 kΩ			2/f <sub>MCK</sub> + 573		2/f <sub>MCK</sub> + 573		2/f <sub>MCK</sub> + 573	ns

(Notes and Caution are listed on the next page, and Remarks are listed on the page after the next page.)

(1) I<sup>2</sup>C standard mode (2/2)(T<sub>A</sub> =  $-40$  to  $+85^\circ\text{C}$ ,  $1.6\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ )

Parameter	Symbol	Conditions	HS (high-speed main) Mode		LS (low-speed main) Mode		LV (low-voltage main) Mode		Unit
			MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
Data setup time (reception)	t <sub>SU:DAT</sub>	$2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	250		250		250		ns
		$1.8\text{ V} (2.4\text{ V}^{\text{Note 3}}) \leq V_{DD} \leq 5.5\text{ V}$	250		250		250		ns
		$1.6\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	—	—	—	—	250		ns
Data hold time (transmission) <sup>Note 2</sup>	t <sub>HD:DAT</sub>	$2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	0	3.45	0	3.45	0	3.45	μs
		$1.8\text{ V} (2.4\text{ V}^{\text{Note 3}}) \leq V_{DD} \leq 5.5\text{ V}$	0	3.45	0	3.45	0	3.45	μs
		$1.6\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	—	—	—	—	0	3.45	μs
Setup time of stop condition	t <sub>SU:STO</sub>	$2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	4.0		4.0		4.0		μs
		$1.8\text{ V} (2.4\text{ V}^{\text{Note 3}}) \leq V_{DD} \leq 5.5\text{ V}$	4.0		4.0		4.0		μs
		$1.6\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	—	—	—	—	4.0		μs
Bus-free time	t <sub>BUF</sub>	$2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	4.7		4.7		4.7		μs
		$1.8\text{ V} (2.4\text{ V}^{\text{Note 3}}) \leq V_{DD} \leq 5.5\text{ V}$	4.7		4.7		4.7		μs
		$1.6\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	—	—	—	—	4.7		μs

- Notes**
1. The first clock pulse is generated after this period when the start/restart condition is detected.
  2. The maximum value (MAX.) of t<sub>HD:DAT</sub> is during normal transfer and a wait state is inserted in the ACK (acknowledge) timing.
  3. Condition in HS (high-speed main) mode

**Caution** The values in the above table are applied even when bit 2 (PIOR2) in the peripheral I/O redirection register (PIOR) is 1. At this time, the pin characteristics (I<sub>OH1</sub>, I<sub>OL1</sub>, V<sub>OH1</sub>, V<sub>OL1</sub>) must satisfy the values in the redirect destination.

**Remark** The maximum value of C<sub>b</sub> (communication line capacitance) and the value of R<sub>b</sub> (communication line pull-up resistor) at that time in each mode are as follows.

Standard mode: C<sub>b</sub> = 400 pF, R<sub>b</sub> = 2.7 kΩ

## 2.6.3 Comparator characteristics

( $T_A = -40$  to  $+85^\circ\text{C}$ ,  $1.6\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ )

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input voltage range	Ivref		0		$V_{DD} - 1.4$	V
	Ivcmp		-0.3		$V_{DD} + 0.3$	V
Output delay	td	$V_{DD} = 3.0\text{ V}$ Input slew rate $> 50\text{ mV}/\mu\text{s}$ Comparator high-speed mode, standard mode			1.2	$\mu\text{s}$
		Comparator high-speed mode, window mode			2.0	$\mu\text{s}$
		Comparator low-speed mode, standard mode		3.0	5.0	$\mu\text{s}$
High-electric-potential reference voltage	VTW+	Comparator high-speed mode, window mode	$0.66V_{DD}$	$0.76V_{DD}$	$0.86V_{DD}$	V
Low-electric-potential reference voltage	VTW-	Comparator high-speed mode, window mode	$0.14V_{DD}$	$0.24V_{DD}$	$0.34V_{DD}$	V
Operation stabilization wait time	tCMP		100			$\mu\text{s}$
Internal reference output voltage <sup>Note</sup>	V <sub>BGR</sub>	$2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ , HS (high-speed main) mode	1.38	1.45	1.50	V

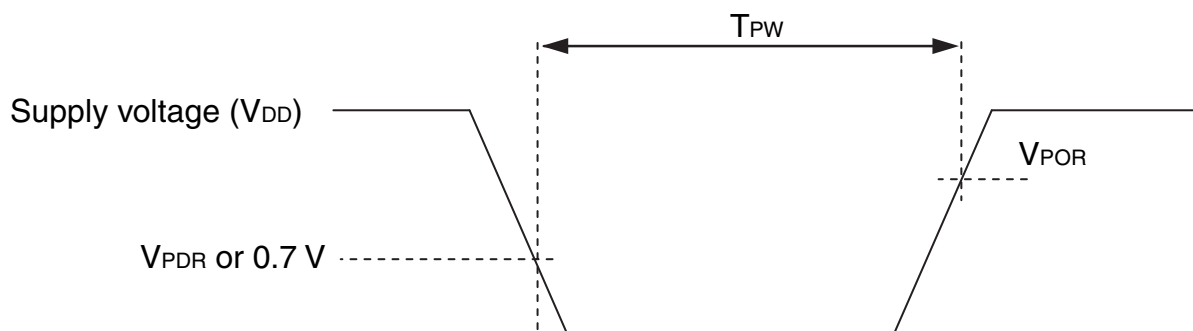
**Note** Cannot be used in LS (low-speed main) mode, LV (low-voltage main) mode, subsystem clock operation, and STOP mode.

## 2.6.4 POR circuit characteristics

( $T_A = -40$  to  $+85^\circ\text{C}$ ,  $V_{SS} = 0\text{ V}$ )

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Detection voltage	V <sub>POR</sub>	When power supply rises	1.47	1.51	1.55	V
	V <sub>PDR</sub>	When power supply falls	1.46	1.50	1.54	V
Minimum pulse width <sup>Note</sup>	T <sub>PW</sub>		300			$\mu\text{s}$

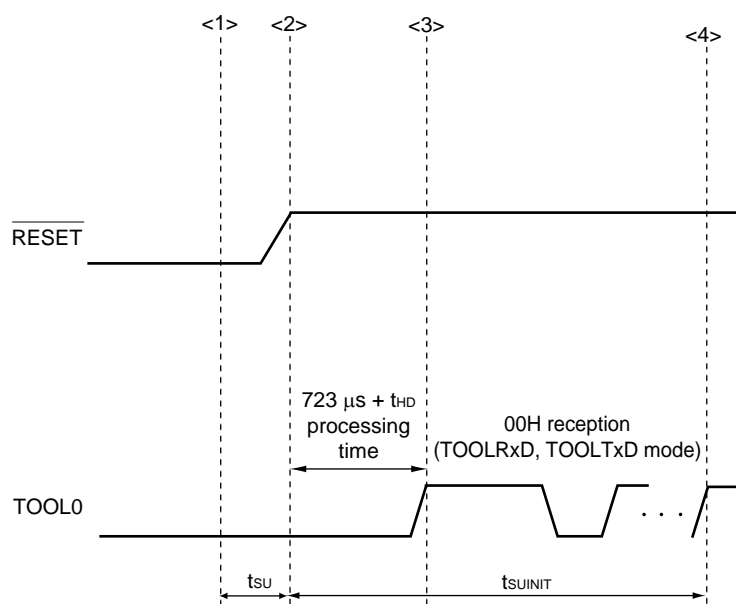
**Note** This is the time required for the POR circuit to execute a reset operation when  $V_{DD}$  falls below  $V_{PDR}$ . When the microcontroller enters STOP mode and when the main system clock ( $f_{\text{MAIN}}$ ) has been stopped by setting bit 0 (HIOSTOP) and bit 7 (MSTOP) of the clock operation status control register (CSC), this is the time required for the POR circuit to execute a reset operation between when  $V_{DD}$  falls below  $0.7\text{ V}$  and when  $V_{DD}$  rises to  $V_{POR}$  or higher.



## 2.11 Timing Specifications for Switching Flash Memory Programming Modes

( $T_A = -40$  to  $+85^\circ\text{C}$ ,  $1.8\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ )

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Time to complete the communication for the initial setting after the external reset is released	$t_{\text{SUINIT}}$	POR and LVD reset must be released before the external reset is released.			100	ms
Time to release the external reset after the TOOL0 pin is set to the low level	$t_{\text{SU}}$	POR and LVD reset must be released before the external reset is released.	10			$\mu\text{s}$
Time to hold the TOOL0 pin at the low level after the external reset is released (excluding the processing time of the firmware to control the flash memory)	$t_{\text{HD}}$	POR and LVD reset must be released before the external reset is released.	1			ms



- <1> The low level is input to the TOOL0 pin.
- <2> The external reset is released (POR and LVD reset must be released before the external reset is released.).
- <3> The TOOL0 pin is set to the high level.
- <4> Setting of the flash memory programming mode by UART reception and completion the baud rate setting.

**Remark**  $t_{\text{SUINIT}}$ : Communication for the initial setting must be completed within 100 ms after the external reset is released during this period.

$t_{\text{SU}}$ : Time to release the external reset after the TOOL0 pin is set to the low level

$t_{\text{HD}}$ : Time to hold the TOOL0 pin at the low level after the external reset is released (excluding the processing time of the firmware to control the flash memory)

## 3.1 Absolute Maximum Ratings

## Absolute Maximum Ratings (1/3)

Parameter	Symbol	Conditions	Ratings	Unit
Supply voltage	$V_{DD}$		$-0.5$ to $+6.5$	V
REGC pin input voltage	$V_{IREGC}$	REGC	$-0.3$ to $+2.8$ and $-0.3$ to $V_{DD} + 0.3$ <sup>Note 1</sup>	V
Input voltage	$V_{I1}$	P00 to P07, P10 to P17, P20 to P27, P30 to P35, P40 to P47, P50 to P57, P60, P61, P70 to P77, P121 to P127, P130, P137	$-0.3$ to $V_{DD} + 0.3$ <sup>Note 2</sup>	V
	$V_{I2}$	P60 and P61 (N-ch open-drain)	$-0.3$ to $+6.5$	V
	$V_{I3}$	EXCLK, EXCLKS, $\overline{\text{RESET}}$	$-0.3$ to $V_{DD} + 0.3$ <sup>Note 2</sup>	V
Output voltage	$V_{O1}$	P00 to P07, P10 to P17, P20 to P27, P30 to P35, P40 to P47, P50 to P57, P60, P61, P70 to P77, P121 to P127, P130, P137	$-0.3$ to $V_{DD} + 0.3$ <sup>Note 2</sup>	V
Analog input voltage	$V_{AI1}$	ANI0, ANI1, ANI16 to ANI26	$-0.3$ to $V_{DD} + 0.3$ and $-0.3$ to $AV_{REF(+)} + 0.3$ <sup>Notes 2, 3</sup>	V

**Notes 1.** Connect the REGC pin to  $V_{SS}$  via a capacitor (0.47 to 1  $\mu\text{F}$ ). This value regulates the absolute maximum rating of the REGC pin. Do not use this pin with voltage applied to it.

**2.** Must be 6.5 V or lower.

**3.** Do not exceed  $AV_{REF(+)} + 0.3$  V in case of A/D conversion target pin.

**Caution** Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

**Remarks 1.** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

**2.**  $AV_{REF(+)}$ : + side reference voltage of the A/D converter.

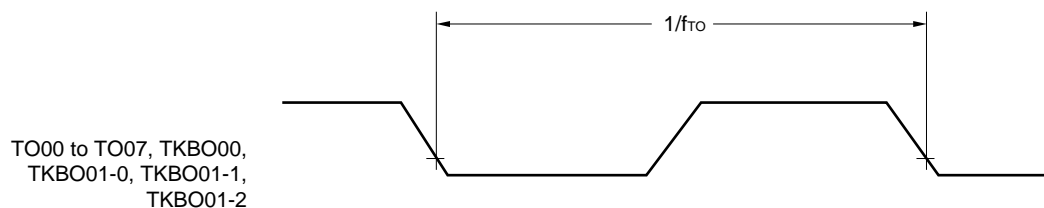
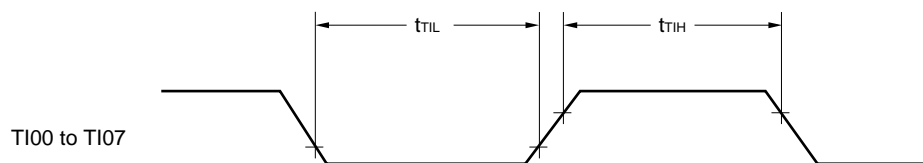
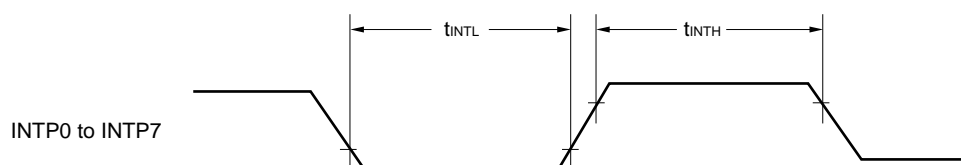
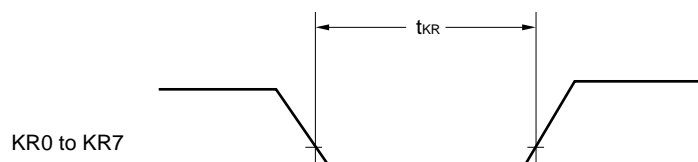
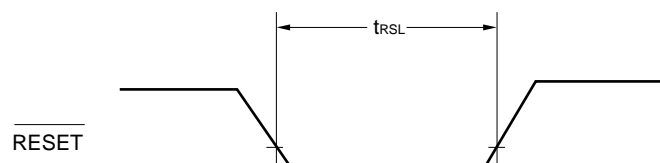
**3.**  $V_{SS}$ : Reference voltage

**( $T_A = -40$  to  $+105^\circ\text{C}$ ,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ )**

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input voltage, high	$V_{IH1}$	P00 to P07, P10 to P17, P22 to P27, P30 to P35, P40 to P47, P50 to P57, P70 to P77, P125 to P127, P130, P137	Normal input buffer	$0.8V_{DD}$	$V_{DD}$	V
	$V_{IH2}$	P03, P05, P06, P16, P17, P34, P43, P44, P46, P47, P53, P55	TTL input buffer $4.0\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	2.2	$V_{DD}$	V
			TTL input buffer $3.3\text{ V} \leq V_{DD} < 4.0\text{ V}$	2.0	$V_{DD}$	V
			TTL input buffer $2.4\text{ V} \leq V_{DD} < 3.3\text{ V}$	1.5	$V_{DD}$	V
	$V_{IH3}$	P20, P21	$0.7V_{DD}$		$V_{DD}$	V
	$V_{IH4}$	P60, P61	$0.7V_{DD}$		6.0	V
	$V_{IH5}$	P121 to P124, P137, EXCLK, EXCLKS, RESET	$0.8V_{DD}$		$V_{DD}$	V
Input voltage, low	$V_{IL1}$	P00 to P07, P10 to P17, P22 to P27, P30 to P35, P40 to P47, P50 to P57, P70 to P77, P125 to P127, P130, P137	Normal input buffer	0	$0.2V_{DD}$	V
	$V_{IL2}$	P03, P05, P06, P16, P17, P34, P43, P44, P46, P47, P53, P55	TTL input buffer $4.0\text{ V} \leq V_{DD} \leq 5.5\text{ V}$	0	0.8	V
			TTL input buffer $3.3\text{ V} \leq V_{DD} < 4.0\text{ V}$	0	0.5	V
			TTL input buffer $2.4\text{ V} \leq V_{DD} < 3.3\text{ V}$	0	0.32	V
	$V_{IL3}$	P20, P21	0		$0.3V_{DD}$	V
	$V_{IL4}$	P60, P61	0		$0.3V_{DD}$	V
	$V_{IL5}$	P121 to P124, P137, EXCLK, EXCLKS, RESET	0		$0.2V_{DD}$	V

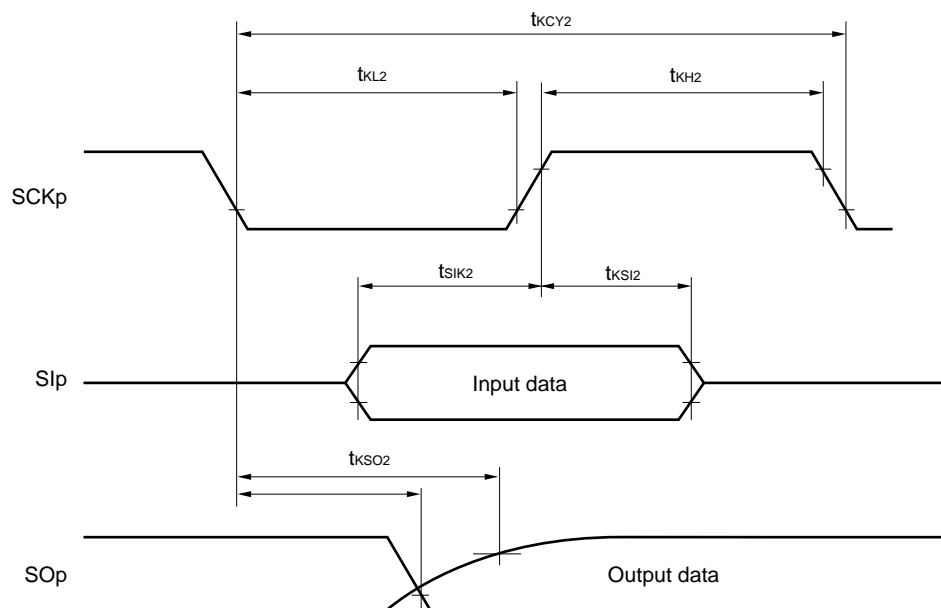
**Caution** The maximum value of  $V_{IH}$  of pins P00, P04 to P07, P16, P17, P35, P42 to P44, P46, P47, P53 to P56, and P130 is  $V_{DD}$ , even in the N-ch open-drain mode.

**Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

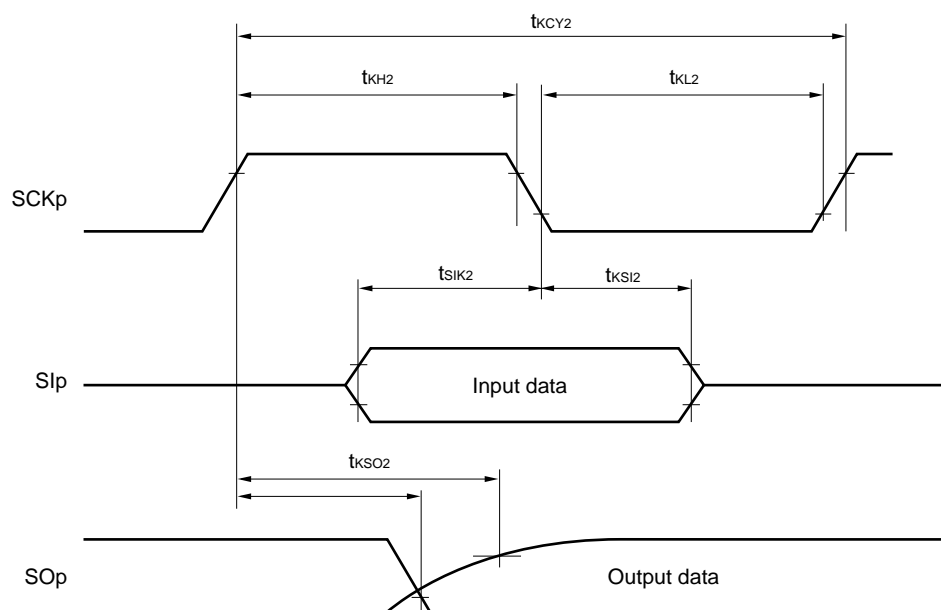
**TI/TO Timing****Interrupt Request Input Timing****Key Interrupt Input Timing****RESET Input Timing**



**CSI mode serial transfer timing (slave mode) (during communication at different potential)**  
**(When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1.)**



**CSI mode serial transfer timing (slave mode) (during communication at different potential)**  
**(When DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.)**



- Remarks 1.**  $R_b[\Omega]$ : Communication line (SO<sub>p</sub>) pull-up resistance,  $C_b[\text{F}]$ : Communication line (SO<sub>p</sub>) load capacitance,  $V_b[\text{V}]$ : Communication line voltage
- 2.** p: CSI number (p = 00, 10), m: Unit number, n: Channel number (mn = 00, 02), g: PIM and POM number (g = 0, 1)
- 3.**  $f_{\text{MCK}}$ : Serial array unit operation clock frequency  
 (Operation clock to be set by the CKS<sub>mn</sub> bit of serial mode register mn (SMR<sub>mn</sub>)  
 m: Unit number, n: Channel number (mn = 00, 02))

**(8) Communication at different potential (1.8 V, 2.5 V, 3 V) (simplified I<sup>2</sup>C mode) (1/2)****( $T_A = -40$  to  $+105^{\circ}\text{C}$ ,  $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = 0\text{ V}$ )**

Parameter	Symbol	Conditions	HS (high-speed main) Mode		Unit
			MIN.	MAX.	
SCLr clock frequency	$f_{SCL}$	$4.0\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ , $2.7\text{ V} \leq V_b \leq 4.0\text{ V}$ , $C_b = 50\text{ pF}$ , $R_b = 2.7\text{ k}\Omega$		400 <sup>Note 1</sup>	kHz
		$2.7\text{ V} \leq V_{DD} < 4.0\text{ V}$ , $2.3\text{ V} \leq V_b \leq 2.7\text{ V}$ , $C_b = 50\text{ pF}$ , $R_b = 2.7\text{ k}\Omega$		400 <sup>Note 1</sup>	kHz
		$4.0\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ , $2.7\text{ V} \leq V_b \leq 4.0\text{ V}$ , $C_b = 100\text{ pF}$ , $R_b = 2.8\text{ k}\Omega$		100 <sup>Note 1</sup>	kHz
		$2.7\text{ V} \leq V_{DD} < 4.0\text{ V}$ , $2.3\text{ V} \leq V_b \leq 2.7\text{ V}$ , $C_b = 100\text{ pF}$ , $R_b = 2.7\text{ k}\Omega$		100 <sup>Note 1</sup>	kHz
		$2.4\text{ V} \leq V_{DD} < 3.3\text{ V}$ , $1.6\text{ V} \leq V_b \leq 2.0\text{ V}$ , $C_b = 100\text{ pF}$ , $R_b = 5.5\text{ k}\Omega$		100 <sup>Note 1</sup>	kHz
Hold time when SCLr = "L"	$t_{LOW}$	$4.0\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ , $2.7\text{ V} \leq V_b \leq 4.0\text{ V}$ , $C_b = 50\text{ pF}$ , $R_b = 2.7\text{ k}\Omega$	1200		ns
		$2.7\text{ V} \leq V_{DD} < 4.0\text{ V}$ , $2.3\text{ V} \leq V_b \leq 2.7\text{ V}$ , $C_b = 50\text{ pF}$ , $R_b = 2.7\text{ k}\Omega$	1200		ns
		$4.0\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ , $2.7\text{ V} \leq V_b \leq 4.0\text{ V}$ , $C_b = 100\text{ pF}$ , $R_b = 2.8\text{ k}\Omega$	4600		ns
		$2.7\text{ V} \leq V_{DD} < 4.0\text{ V}$ , $2.3\text{ V} \leq V_b \leq 2.7\text{ V}$ , $C_b = 100\text{ pF}$ , $R_b = 2.7\text{ k}\Omega$	4600		ns
		$2.4\text{ V} \leq V_{DD} < 3.3\text{ V}$ , $1.6\text{ V} \leq V_b \leq 2.0\text{ V}$ , $C_b = 100\text{ pF}$ , $R_b = 5.5\text{ k}\Omega$	4650		ns
Hold time when SCLr = "H"	$t_{HIGH}$	$4.0\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ , $2.7\text{ V} \leq V_b \leq 4.0\text{ V}$ , $C_b = 50\text{ pF}$ , $R_b = 2.7\text{ k}\Omega$	620		ns
		$2.7\text{ V} \leq V_{DD} < 4.0\text{ V}$ , $2.3\text{ V} \leq V_b < 2.7\text{ V}$ , $C_b = 50\text{ pF}$ , $R_b = 2.7\text{ k}\Omega$	500		ns
		$4.0\text{ V} \leq V_{DD} \leq 5.5\text{ V}$ , $2.7\text{ V} \leq V_b \leq 4.0\text{ V}$ , $C_b = 100\text{ pF}$ , $R_b = 2.8\text{ k}\Omega$	2700		ns
		$2.7\text{ V} \leq V_{DD} < 4.0\text{ V}$ , $2.3\text{ V} \leq V_b \leq 2.7\text{ V}$ , $C_b = 100\text{ pF}$ , $R_b = 2.7\text{ k}\Omega$	2400		ns
		$2.4\text{ V} \leq V_{DD} < 3.3\text{ V}$ , $1.6\text{ V} \leq V_b \leq 2.0\text{ V}$ , $C_b = 100\text{ pF}$ , $R_b = 5.5\text{ k}\Omega$	1830		ns

(Notes and Caution are listed on the next page, and Remarks are listed on the page after the next page.)

### 3.7 LCD Characteristics

#### 3.7.1 External resistance division method

##### (1) Static display mode

( $T_A = -40$  to  $+105^\circ\text{C}$ ,  $V_{L4} (\text{MIN.}) \leq V_{DD} \leq 5.5 \text{ V}$ ,  $V_{SS} = 0 \text{ V}$ )

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
LCD drive voltage	$V_{L4}$		2.0		$V_{DD}$	V

##### (2) 1/2 bias method, 1/4 bias method

( $T_A = -40$  to  $+105^\circ\text{C}$ ,  $V_{L4} (\text{MIN.}) \leq V_{DD} \leq 5.5 \text{ V}$ ,  $V_{SS} = 0 \text{ V}$ )

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
LCD drive voltage	$V_{L4}$		2.7		$V_{DD}$	V

##### (3) 1/3 bias method

( $T_A = -40$  to  $+105^\circ\text{C}$ ,  $V_{L4} (\text{MIN.}) \leq V_{DD} \leq 5.5 \text{ V}$ ,  $V_{SS} = 0 \text{ V}$ )

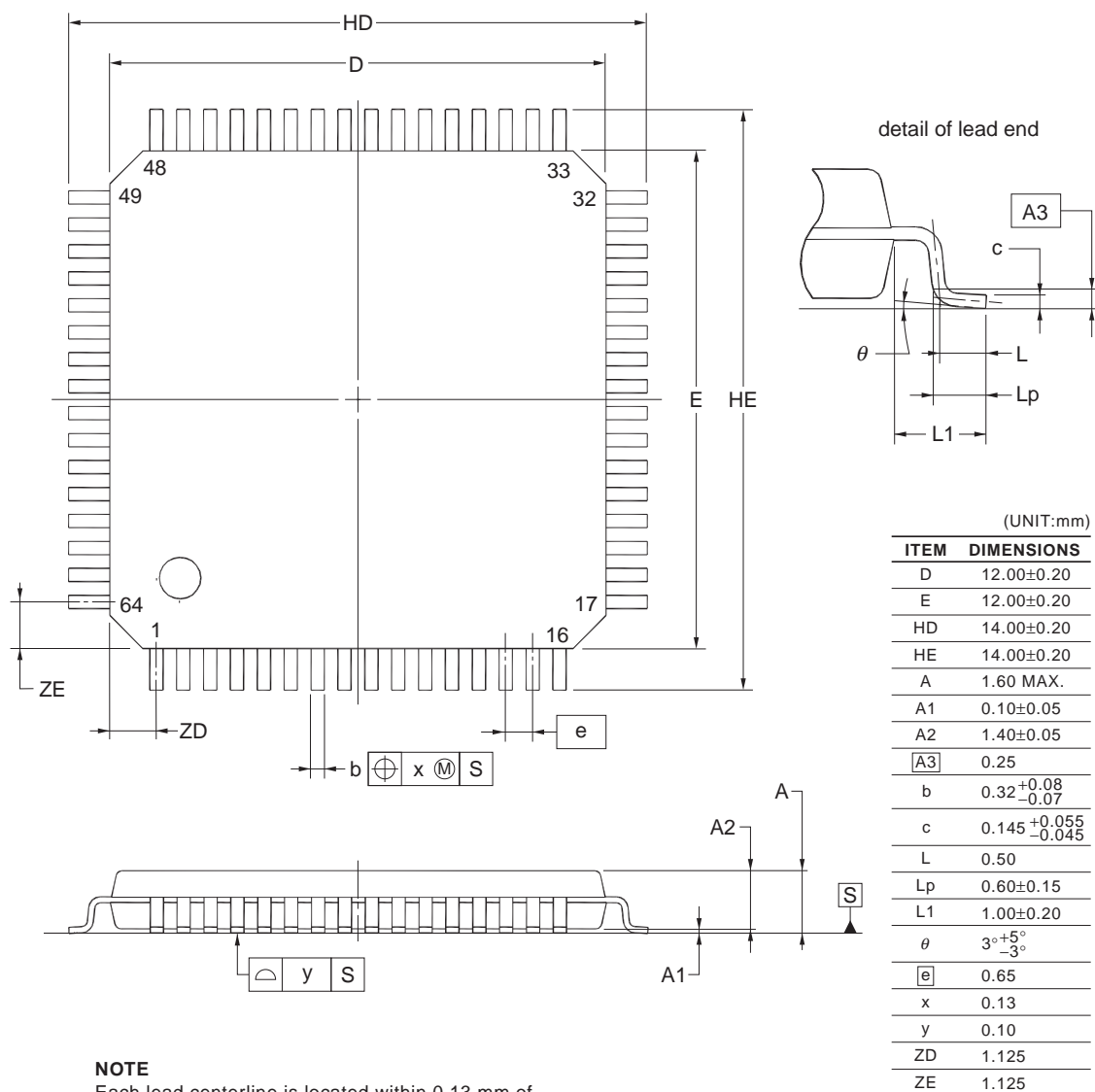
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
LCD drive voltage	$V_{L4}$		2.5		$V_{DD}$	V

## 4. PACKAGE DRAWINGS

### 4.1 64-pin Products

R5F10WLAFA, R5F10WLCAFA, R5F10WLDAFA, R5F10WLEAFA, R5F10WLFafa, R5F10WLGafa

JEITA Package Code	RENESAS Code	Previous Code	MASS (TYP.) [g]
P-LQFP64-12x12-0.65	PLQP0064JA-A	P64GK-65-UET-2	0.51



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R5F10WLAAFB, R5F10WLCAFB, R5F10WLDAFB, R5F10WLEAFB, R5F10WLFAFB, R5F10WLGAFB,  
R5F10WLAGFB, R5F10WLCGFB, R5F10WLDGFB, R5F10WLEGFB, R5F10WLFGB, R5F10WLGGB

